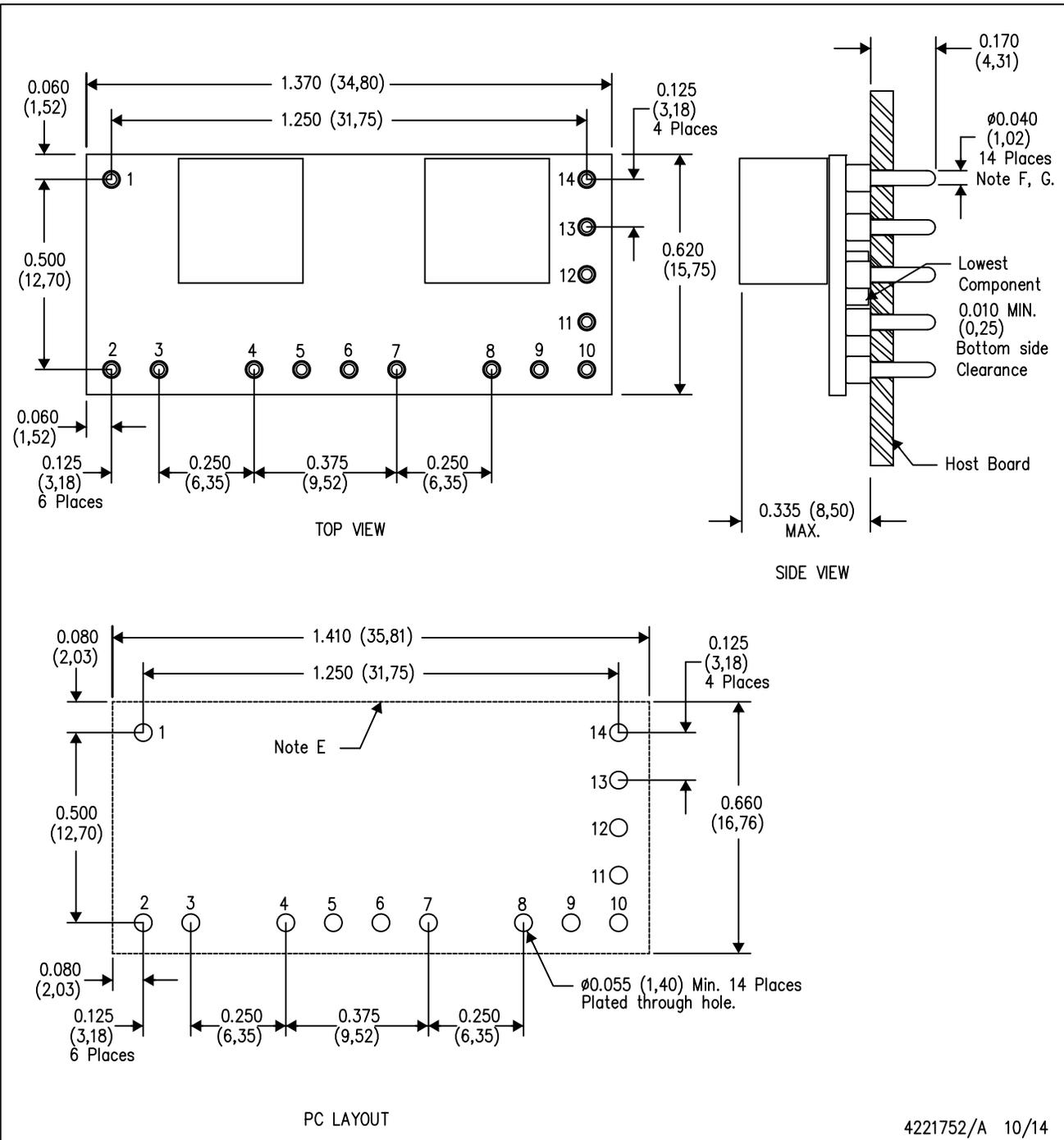


MECHANICAL DATA

EHM (R-PDSS-T14)

DOUBLE SIDED MODULE



- NOTES:
- All linear dimensions are in inches (mm).
 - This drawing is subject to change without notice.
 - 2 place decimals are ± 0.030 ($\pm 0,76$ mm).
 - 3 place decimals are ± 0.010 ($\pm 0,25$ mm).
 - Recommended keep out area for user components.

- Pins are 0.040" (1,02) diameter with 0.070" (1,78) diameter standoff shoulder.
- All pins: Material - Copper Alloy
Finish - Tin (100%) over Nickel plate

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